



(Translation)

**Delivery No.:** 9-5-2004-024478162  
**Delivery Date:** June 23, 2004  
**Response Deadline:** August 23, 2004

## NOTICE REQUESTING SUBMISSION OF OPINION

**Applicant(s):** *Name:* Citizen Electronics Co., Ltd. (Applicant's Code: 519987010369)  
*Address:* 1-23-1, Kamikurechi, Fujiyoshida-shi, Yamanashi-ken, Japan

**Attorney(s) for Applicant(s):** *Name:* Lee International Attorney(s)  
*Address:* Kukdong Bldg. 14<sup>th</sup> Floor, Chungmuro 3-ka  
Chung-ku, Seoul 100-705, Korea (Lee International IP&  
Law Group)

**Case:** Patent Application No. 10-2002-0026347

**For:** CONDENSER MICROPHONE AND METHOD FOR MANUFACTURING  
CONDENSER MICROPHONES

As the above-identified application, upon examination, has been rejected on the following grounds, this Notice is hereby made pursuant to Article 63 of the Patent Act. If the applicant should have any arguments or would like to make an amendment to the application, the applicant may submit such arguments [Annexed Form No. 25(2) to the Administrative Regulations under the Patent Act] and/or amendment [Annexed Form No. 5 to the Administrative Regulations under the Patent Act] to this Office by the response deadline noted above. (This deadline may be extended upon request on a monthly basis; however, there shall be no official notification regarding the approval of any extension.)

### GROUND

The invention claimed in Claims 1-7 of the present application is considered to be easily conceivable by one skilled in the art, prior to the filing of the present application, in view of the reasons set forth in the "Remarks" below. Therefore, the claimed invention is not patentable in view of Article 29, Paragraph 2 of the Patent Act.

### REMARKS

Claims 1-7 of the present application relate to a condenser microphone comprising a back plate secured to a substrate, a spacer, a diaphragm electrode and a sound collecting hole, and a method for manufacturing condenser microphones by preparing a substrate aggregation, a back plate aggregation and a spacer aggregation and stacking these aggregations. However, the claimed invention is easily conceivable by one skilled in the art from Japanese Unexamined Patent Publication No. Hei 13-069596 (March 16, 2001; "cited reference"). The cited reference, which relates to a condenser microphone and a method for manufacturing the same, is characterized by using a method of stacking each section in manufacturing electret condenser microphones thereby minimizing the size of the microphones, reducing costs and facilitating the manufacturing method.

Document Annexed: Copy of Japanese Unexamined Patent Publication No. Hei 13-069596  
(March 16, 2001)

This 23<sup>rd</sup> day of June, 2004

**Patent Examiner (sealed)**  
**Electronic Examination Division**  
**Electrical & Electronic Examination Bureau**  
**Korean Intellectual Property Office**